APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention

[STRUCTURE OF THIN-FILM TRANSISTOR AND METHOD AND EQUIPMENT FOR FABRICATING THE STRUCTURE]

Application Type:

regular, utility

Attorney Docket Number:

11340-US-PA

Correspondence address:

Customer Number:

31561



Priority Data:

Doc.No: 2003-164366; Country -JP; Date: 2003-05-07 us-priority-claimed

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